

MICRO
QUALITY
SEMICONDUCTOR, INC

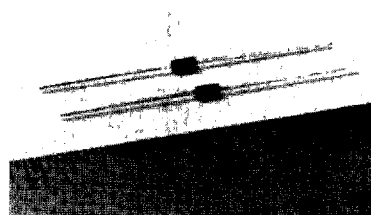
T-03-13

1 Amp Fast Recovery Time Rectifiers

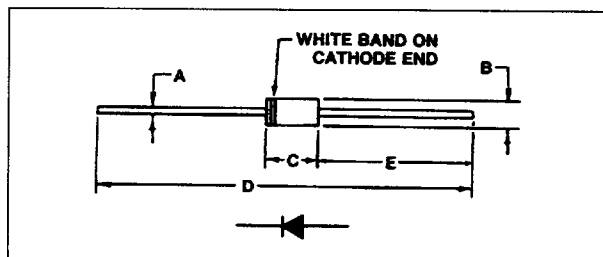
200 Nanosecond Reverse Recovery Time at
100V, 200V, 400V, and 600V V_{RRM} Ratings

350 Nanosecond Reverse Recovery Time
800V and 1000V V_{RRM} Ratings

30 Amp Peak One Half Cycle Surge Rating



LTR.	INCHES	MILLIMETERS
A	.030-.034 Dia.	.76-.86 Dia.
B	.10-.107 Dia.	2.54-2.72 Dia.
C	.185-.205	4.70-5.21
D	2.40	60.96
E	.9-1.1	22.9-28.0



MAXIMUM RATINGS at $T_A = 25^\circ\text{C}$ (Unless Otherwise Specified)

RATINGS	SYMBOL	V110X	V120X	V140X	V160X	V180X	V1100X	UNITS
DC Blocking Voltage	V_{RRM}							
Working Peak Reverse Voltage	V_{RRM}	100	200	400	600	800	1000	Volt
Peak Repetitive Reverse Voltage	V_{RRM}							
RMS Reverse Voltage	V_{RRMS}	70	140	280	420	560	700	Volt
Peak Surge Current, 1/2 Cycle @ 60Hz (Non-Rep) and $T_A = 40^\circ\text{C}$	I_{FSM}	30						Amp
DC Forward Current @ $T_A = 40^\circ\text{C}$	I_O	1						Amp
Junction Storage Temperature Range	T_{STG}	- 50 to + 175						$^\circ\text{C}$
Junction Operating Temperature Range	T_J	- 50 to + 150*						$^\circ\text{C}$

* T_J MAX = 125°C when V_{RRM} Exceeds 200V

ELECTRICAL CHARACTERISTICS At $T_A = 25^\circ\text{C}$ (Unless Otherwise Specified)

CHARACTERISTICS	SYMBOL	V110X	V120X	V140X	V160X	V180X	V1100X	UNITS
Max Reverse Recovery Time $I_F = 1\text{ A}$, $I_R = 2\text{ A}$	t_{rr}	200				350	350	nsec
Max Reverse Current @ Rated V_{RRM} @ $T_A = 40^\circ\text{C}$	I_{RM}	10						μA
Max Reverse Current @ Rated V_{RRM} @ $T_A = 125^\circ\text{C}$	I_{RM}	2						mA
Max Instantaneous Fwd Voltage Drop @ 1 A	V_{FM}	1.1						Volt

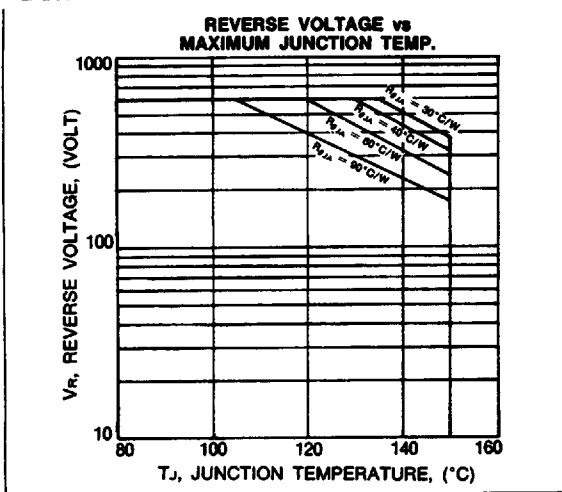


FIGURE 1

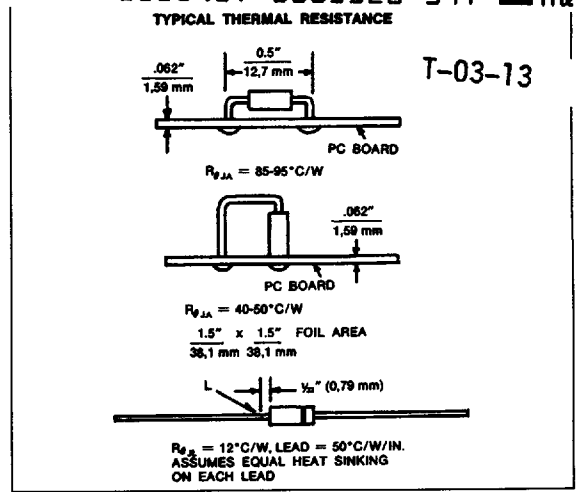


FIGURE 6

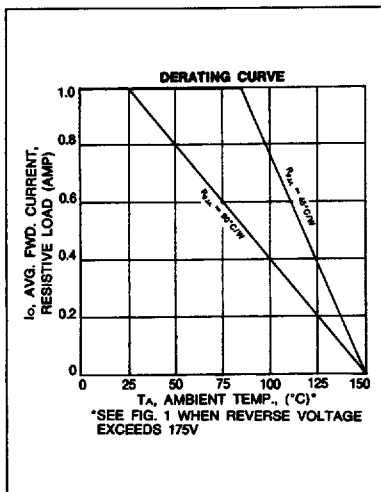


FIGURE 2

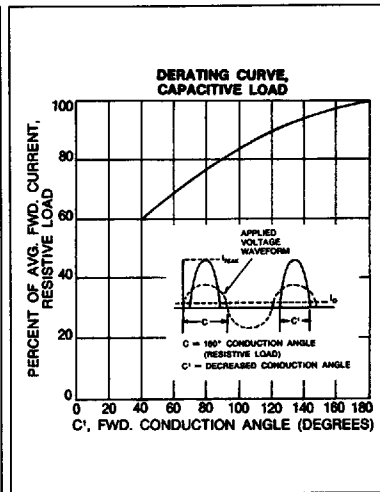


FIGURE 3

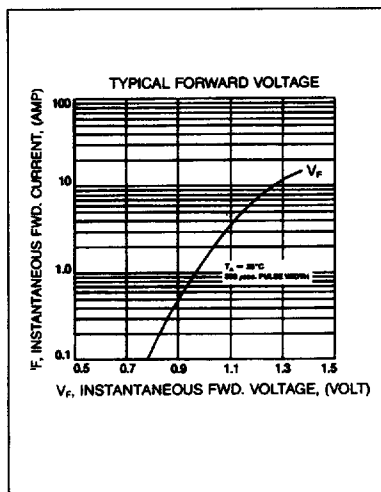
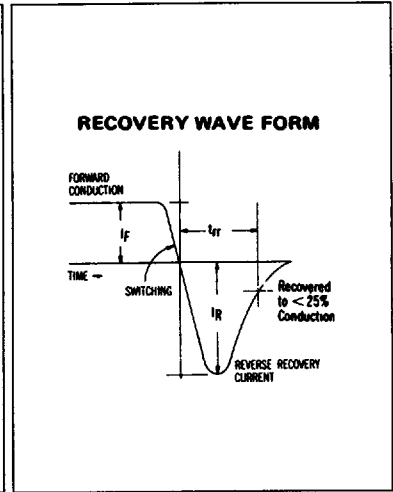


FIGURE 4

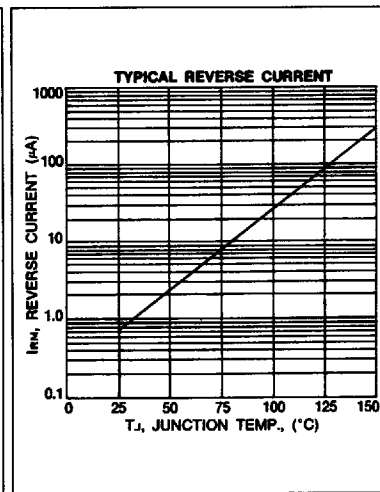


FIGURE 5